

2N5060 Series

Sensitive Gate Silicon Controlled Rectifiers Reverse Blocking Thyristors

Annular PNP devices designed for high volume consumer applications such as relay and lamp drivers, small motor controls, gate drivers for larger thyristors, and sensing and detection circuits. Supplied in an inexpensive plastic TO-92/TO-226AA package which is readily adaptable for use in automatic insertion equipment.

Features

- Sensitive Gate Trigger Current – 200 μ A Maximum
- Low Reverse and Forward Blocking Current – 50 μ A Maximum, $T_C = 110^\circ\text{C}$
- Low Holding Current – 5 mA Maximum
- Passivated Surface for Reliability and Uniformity
- These are Pb-Free Devices

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) ($T_J = -40$ to 110°C , Sine Wave, 50 to 60 Hz, $R_{GK} = 1\text{ k}\Omega$)	V_{DRM} , V_{RRM}	30 60 100 200	V
On-State Current RMS (180° Conduction Angles; $T_C = 80^\circ\text{C}$)	$I_{T(RMS)}$	0.8	A
*Average On-State Current (180° Conduction Angles) ($T_C = 67^\circ\text{C}$) ($T_C = 102^\circ\text{C}$)	$I_{T(AV)}$	0.51 0.255	A
*Peak Non-repetitive Surge Current, $T_A = 25^\circ\text{C}$ (1/2 cycle, Sine Wave, 60 Hz)	I_{TSM}	10	A
Circuit Fusing Considerations ($t = 8.3\text{ ms}$)	I^2t	0.4	A^2s
*Average On-State Current (180° Conduction Angles) ($T_C = 67^\circ\text{C}$) ($T_C = 102^\circ\text{C}$)	$I_{T(AV)}$	0.51 0.255	A
*Forward Peak Gate Power (Pulse Width \leq 1.0 μsec ; $T_A = 25^\circ\text{C}$)	P_{GM}	0.1	W
*Forward Average Gate Power ($T_A = 25^\circ\text{C}$, $t = 8.3\text{ ms}$)	$P_{G(AV)}$	0.01	W
*Forward Peak Gate Current (Pulse Width $\leq 1.0\text{ }\mu\text{sec}$; $T_A = 25^\circ\text{C}$)	I_{GM}	1.0	A
*Reverse Peak Gate Voltage (Pulse Width $\leq 1.0\text{ }\mu\text{sec}$; $T_A = 25^\circ\text{C}$)	V_{RGM}	5.0	V
*Operating Junction Temperature Range	T_J	-40 to $+110$	$^\circ\text{C}$
*Storage Temperature Range	T_{stg}	-40 to $+150$	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

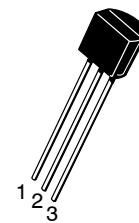
*Indicates JEDEC Registered Data.



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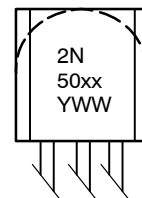
<http://onsemi.com>

SILICON CONTROLLED RECTIFIERS 0.8 A RMS, 30 – 200 V



TO-92
CASE 29
STYLE 10

MARKING DIAGRAM



50xx Specific Device Code
Y = Year
WW = Work Week

PIN ASSIGNMENT

1	Cathode
2	Gate
3	Anode

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

2N5060 Series

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
*Thermal Resistance, Junction-to-Case (Note 2)	$R_{\theta JC}$	75	$^{\circ}\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	200	$^{\circ}\text{C/W}$

2. This measurement is made with the case mounted "flat side down" on a heatsink and held in position by means of a metal clamp over the curved surface.

*Indicates JEDEC Registered Data.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

*Peak Repetitive Forward or Reverse Blocking Current (Note 3) ($V_{AK} = \text{Rated } V_{DRM} \text{ or } V_{RRM}$)	I_{DRM}, I_{RRM}	–	–	10	μA
$T_C = 25^{\circ}\text{C}$		–	–	50	μA
$T_C = 110^{\circ}\text{C}$		–	–		

ON CHARACTERISTICS

*Peak Forward On-State Voltage (Note 4) ($I_{TM} = 1.2 \text{ A peak @ } T_A = 25^{\circ}\text{C}$)	V_{TM}	–	–	1.7	V
Gate Trigger Current (Continuous DC) (Note 5) *($V_{AK} = 7.0 \text{ Vdc}, R_L = 100 \Omega$)	I_{GT}	–	–	200	μA
$T_C = 25^{\circ}\text{C}$		–	–	350	
$T_C = -40^{\circ}\text{C}$		–	–		
Gate Trigger Voltage (Continuous DC) (Note 5) *($V_{AK} = 7.0 \text{ Vdc}, R_L = 100 \Omega$)	V_{GT}	–	–	0.8	V
$T_C = 25^{\circ}\text{C}$		–	–	1.2	
$T_C = -40^{\circ}\text{C}$		–	–		
*Gate Non-Trigger Voltage ($V_{AK} = \text{Rated } V_{DRM}, R_L = 100 \Omega, T_C = 110^{\circ}\text{C}$)	V_{GD}	0.1	–	–	V
Holding Current (Note 3) *($V_{AK} = 7.0 \text{ Vdc}, \text{initiating current} = 20 \text{ mA}$)	I_H	–	–	5.0	mA
$T_C = 25^{\circ}\text{C}$		–	–	10	
$T_C = -40^{\circ}\text{C}$		–	–		
Turn-On Time Delay Time Rise Time ($I_{GT} = 1.0 \text{ mA}, V_D = \text{Rated } V_{DRM},$ Forward Current = $1.0 \text{ A}, di/dt = 6.0 \text{ A}/\mu\text{s}$)	t_d t_r	– –	3.0 0.2	– –	μs
Turn-Off Time (Forward Current = 1.0 A pulse, Pulse Width = $50 \mu\text{s}$, 0.1% Duty Cycle, $di/dt = 6.0 \text{ A}/\mu\text{s}$, $dv/dt = 20 \text{ V}/\mu\text{s}, I_{GT} = 1 \text{ mA}$)	t_q				μs
2N5060, 2N5061		–	10	–	
2N5062, 2N5064		–	30	–	

DYNAMIC CHARACTERISTICS

Critical Rate of Rise of Off-State Voltage (Rated V_{DRM} , Exponential, $R_{GK} = 1 \text{ k}\Omega$)	dv/dt	–	30	–	$\text{V}/\mu\text{s}$
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*Indicates JEDEC Registered Data.

3. $R_{GK} = 1000 \Omega$ is included in measurement.

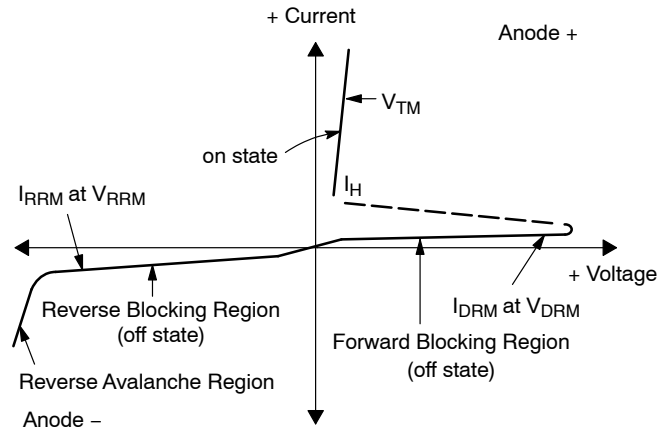
4. Forward current applied for 1 ms maximum duration, duty cycle $\leq 1\%$.

5. R_{GK} current is not included in measurement.

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Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Off State Forward Voltage
I_{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Off State Reverse Voltage
I_{RRM}	Peak Reverse Blocking Current
V_{TM}	Peak on State Voltage
I_H	Holding Current



CURRENT DERATING

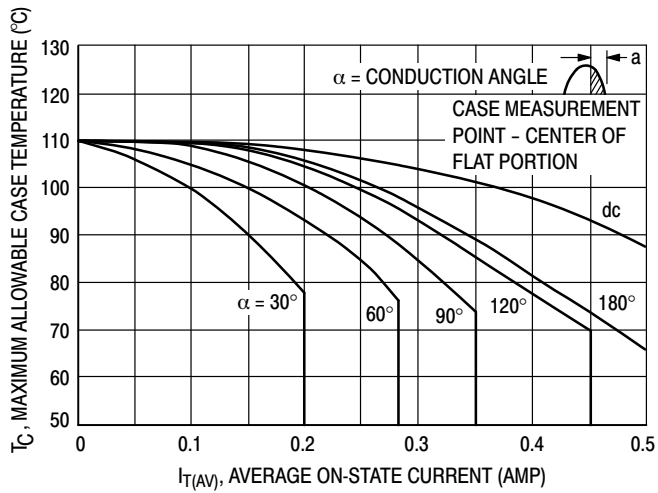


Figure 1. Maximum Case Temperature

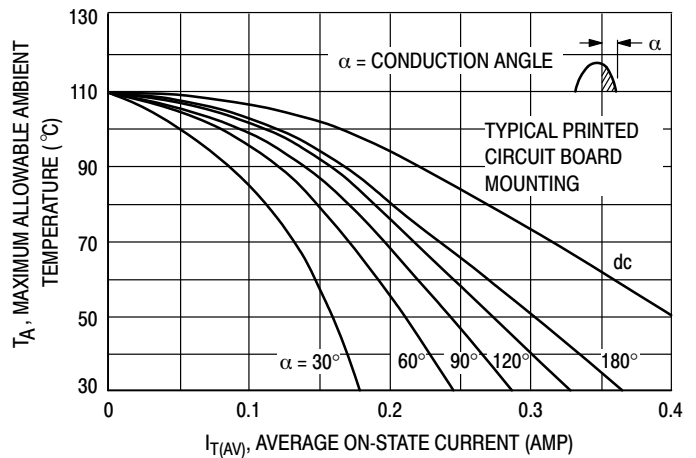


Figure 2. Maximum Ambient Temperature

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CURRENT DERATING

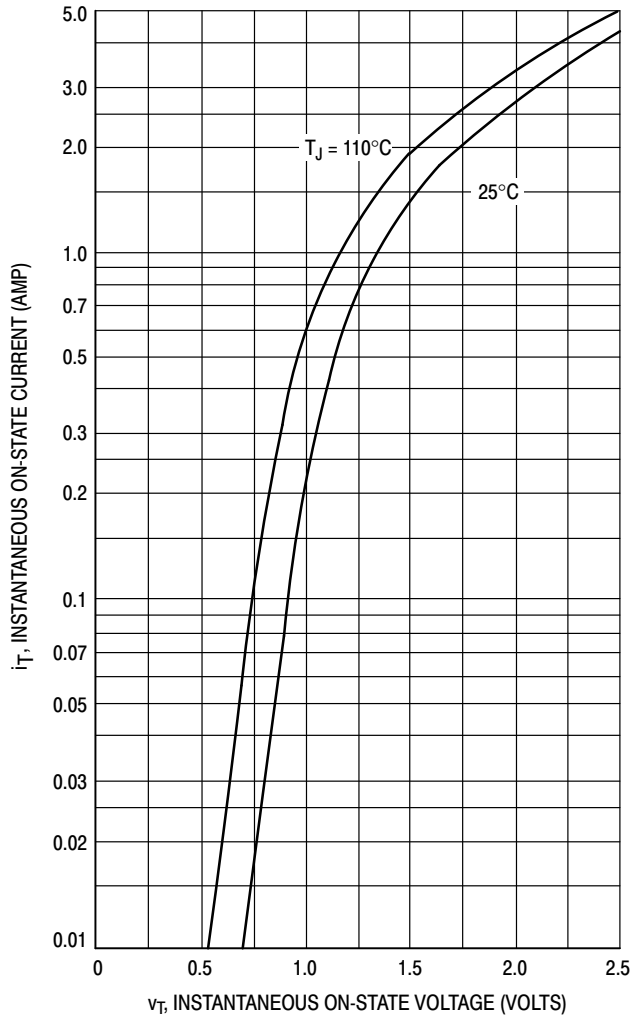


Figure 3. Typical Forward Voltage

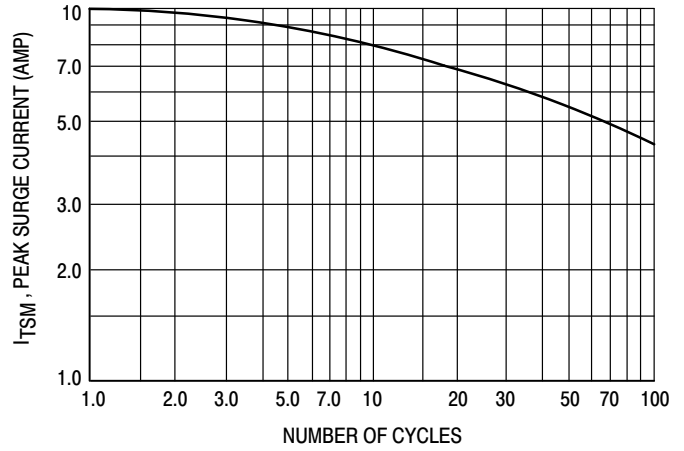


Figure 4. Maximum Non-Repetitive Surge Current

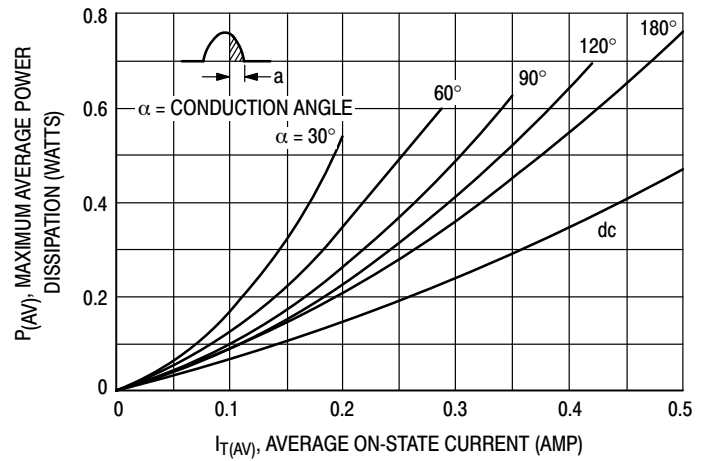


Figure 5. Power Dissipation

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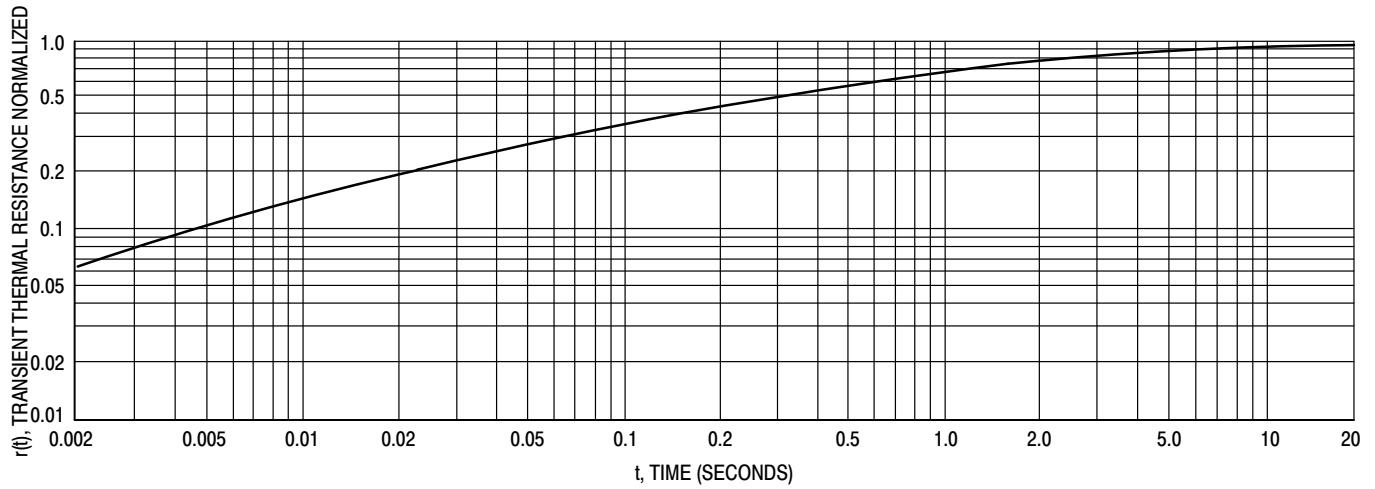


Figure 6. Thermal Response

TYPICAL CHARACTERISTICS

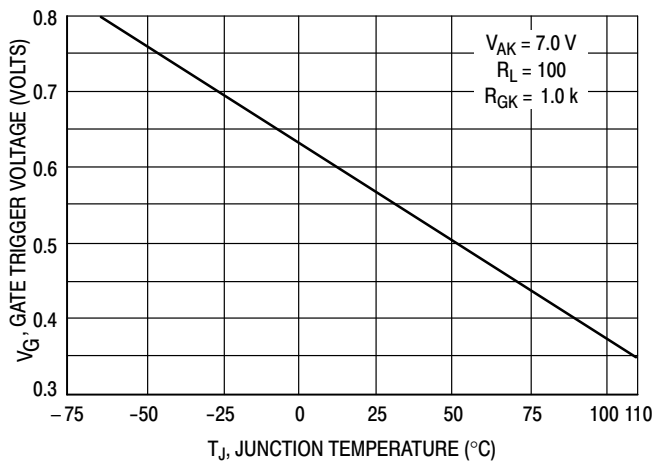


Figure 7. Typical Gate Trigger Voltage

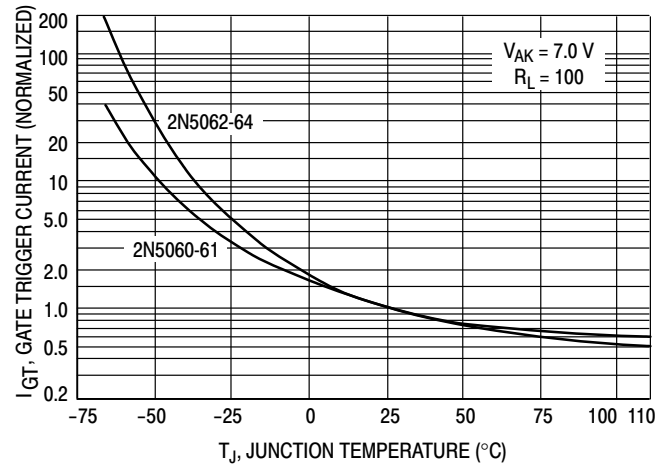


Figure 8. Typical Gate Trigger Current

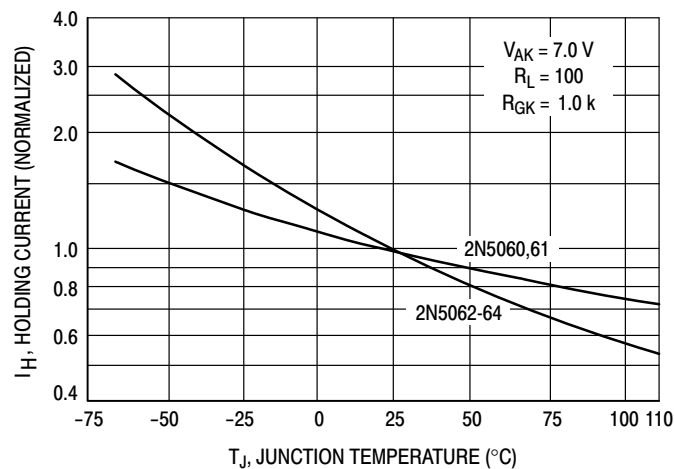


Figure 9. Typical Holding Current

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ORDERING INFORMATION

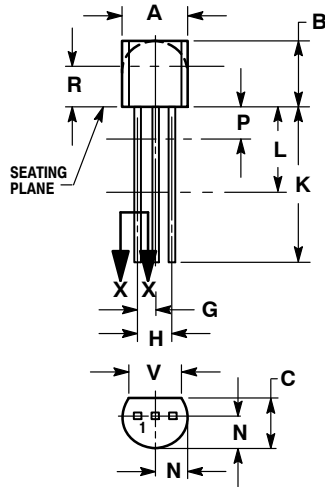
Device	Package	Shipping†
2N5060G	TO-92 (Pb-Free)	5000 Units / Box
2N5060RLRA	TO-92	2000 / Tape & Reel
2N5060RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
2N5060RLRMG	TO-92 (Pb-Free)	2000 / Ammo Pack
2N5061G	TO-92 (Pb-Free)	5000 Units / Box
2N5061RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
2N5062G	TO-92 (Pb-Free)	5000 Units / Box
2N5062RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
2N5064RLRMG	TO-92 (Pb-Free)	2000 / Ammo Pack
2N5064RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
2N5064G	TO-92 (Pb-Free)	5000 Units / Box

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

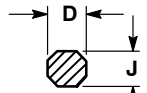
2N5060 Series

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 ISSUE AM



STRAIGHT LEAD
BULK PACK

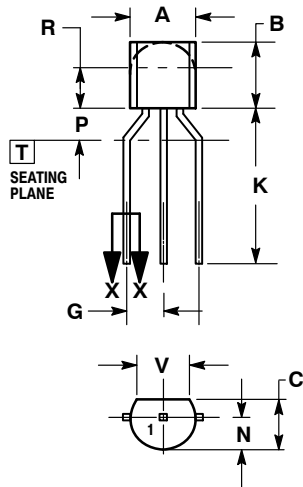


SECTION X-X

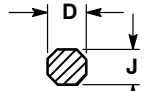
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	---	12.70	---
L	0.250	---	6.35	---
N	0.080	0.105	2.04	2.66
P	---	0.100	---	2.54
R	0.115	---	2.93	---
V	0.135	---	3.43	---



BENT LEAD
TAPE & REEL
AMMO PACK



SECTION X-X


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	MILLIMETERS	
	MIN	MAX
A	4.45	5.20
B	4.32	5.33
C	3.18	4.19
D	0.40	0.54
G	2.40	2.80
J	0.39	0.50
K	12.70	---
N	2.04	2.66
P	1.50	4.00
R	2.93	---
V	3.43	---

STYLE 10:

1. CATHODE
2. GATE
3. ANODE

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